DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if phural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PROCESS FOR USING PHOTO-DEFINABLE LAYERS IN THE MANUFACTURE OF SEMICONDUCTOR DEVICES AND RESULTING STRUCTURES OF SAME, the specification of which:

specification of which:		11 -2 11020 1210 14	SOLITING STRUCTURES OF SAME, the
X is attached	hereto.		
was filed or	1;	as Application Serial No	
I hereby state including the claims.	that I have revi	ewed and understand the co	ontents of the above identified specification
I acknowledge claimed in this application	the duty to disc on as "materiality	lose information which is n " is defined in Title 37 of the	naterial to patentability of the subject matter Code of Federal Regulations, § 1.56.
disclosed in the prior U United States Code, § 1	nited States applicated in acknowled Code of Federal national or PCT	lication in the manner provinge the duty to disclose info Regulations & 1.56 which b	ed States to which I am entitled under Title 35 f each of the claims of this application is not ded by the first paragraph of Title 35 of the rmation which is material to patentability as ecame available between the filing date of the
N/A			
N/A (Application	Serial No.)	(Filing Date)	(Status)
Send correspondence to	:	(,	(Status)
	Richard D.	Form For	
	Jones O'K	eefe, Egan & Peterman LLP	
	1101 Canit	al of TX Hwy So. C-200	
	Austin, TX	78746	
that willful false stateme	nts and the like s	so made are numichable to s	lige are true and that all statements made on statements were made with the knowledge ne or imprisonment, or both, under Title 18 ements may jeopardize the validity of the
Full name of first or sole	inventor: Bra	dley J. Howard	
nventor's Signature:	Brad	By Howard	<u></u>
Date:	9-3-9	Middle Initial, Last)	_
Residence Address:	5694 Schoo		
City, State, Country: Citizenship:	Boise, ID 82 USA	3716. United States of Amer	ica
ost Office Address:		dence address	